BALI series

Host based Wi-Fi (802.11a/b/g/n/ac) Modules

I952HC00
EVIA USB Datasheet

Version 1.0

For additional Information, please contact info@ivativ.com

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Table of Contents

1 Overview 5
2 Features 7
2.1 WLAN Features 7
3 Module block Diagram 8
4 Pin Definition 9
4.1 Pin-out with description 9
4.2 Pin Table 10
5 Electrical Specifications 13
5.1 Absolute maximum ratings 13
5.2 Recommended Operating Conditions 13
5.3 Digital logic characteristics 14
5.4 WLAN RF Characteristics ..... **Error! Bookmark not defined.**
6 Software 19
6.1 Software Architecture 19
6.2 WLAN 19
7 Package Description 20
7.1 Mechanical characteristics 20
7.2 Physical Dimensions, Pad Location and Landing Pattern 20
8 Regulatory Qualifications and Approvals 21
8.1 FCC Compliance 21
8.1.1 FCC Compliance Statement 21
8.1.2 RF Exposure compliance statement 21
8.1.3 Labelling Instruction for Host Product Integrator 22
8.1.4 Installation Notice to Host Product Manufacturer 22
8.1.5 Antenna Change Notice to Host manufacturer 22
8.1.6 FCC other Parts, Part 15B Compliance Requirements for Host product manufacturer 23
8.2 IC 23
8.2.1 ISED compliance statement 24
8.2.2 ISED Radiation Exposure statement 25
8.2.3 End Product Labeling instruction 25
8.3 CE 25

8.4 TELEC 25
8.5 Pre-Approved antennas 25
9 Product Shipping, Storage and Handling 27
9.1 Packaging Information 27
9.2 Storage and Baking Instructions 27
9.3 Mounting process and soldering recommendations 27
10 Product label and ordering information 28
10.1 Part ordering 29
Contact Information 29

Table of Figures

Figure 1: EVIA Block Diagram with Antenna Pin 8
Figure 2: EVIA Module Pin Diagram 9
Figure 3: EVIA Software Architecture 19
Figure 4: Product Labeling 28

List of Tables

Table 1: EVIA Module Specifications 6
Table 2: EVIA Module Pin Table 12
Table 3: Absolute maximum ratings 13
Table 4: Recommended operating conditions 14
Table 5: General DC electrical characteristics (for VDDIO = 3.3V I/O operation) 14
Table 6: WLAN RF characteristics per chain operation ..... **Error! Bookmark not defined.**
Table 7: Transmit power at 2.4 GHz ..... **Error! Bookmark not defined.**
Table 8: Transmit power at 5 GHz ..... **Error! Bookmark not defined.**
Table 9: Receive minimum input level sensitivity at chip input at 2.4 GHz for configuration at 25°C . **Error! Bookmark not defined.**
Table 10: Receive minimum input level sensitivity at chip input at 5 GHz at 25°C ..... **Error! Bookmark not defined.**
Table 11: Maximum input level sensitivity at 25°C ..... **Error! Bookmark not defined.**
Table 12: Mechanical characteristics 20
Table 13: Certified Antennas 26
Table 14: Module Label Description 28
Table 15: Part Ordering for EVIA 29
Table 16: Part ordering for EVIA EVK/DVK 29

1 Overview

EVIA USB is a high-performance certified wireless module supporting dual-band 1-stream (1T1R) Wi-Fi 802.11 a/b/g/n/ac. These modules come with integrated MAC, baseband, crystal, OTP memory and RF front-end components supporting a single antenna for dual-band Wi-Fi. This module supports antenna diversity for best performance. EVIA USB will be interfaced to host processor by using USB 2.0. It enables low-power designs by utilizing multiple advanced power-saving techniques including wake on wireless and many host off-loading features. This module is based on Qualcomm QCA9377 SoC and connects to host processor with USB 2.0 (Wi-Fi) host interfaces.

They are offered in custom LGA package with RF pin. These modules are offered in Industrial and commercial temperature grades and are certified for FCC, IC, ETSI/CE, and TELEC. Approvals for other countries may be possible upon request.

Module specifications

WLAN Technology	802.11 a/b/g/n, 1-stream MU-MIMO 802.11ac
Frequency band	2.4GHz, 5GHz
On air data rates	**2.4GHz** 11b - 1, 2, 5.5, 11Mbps 11g - 6, 9, 12, 18, 24, 36, 48, 54Mbps 11n - MCS0 to MCS7 or up-to 150Mbps **5GHz** 11a - 6,9,12,18,24,36,48, 54Mbps 11n/ac - MCS0 to MCS9 or Up to 433Mbps
Security features	WPA/WPA2 -PSK TKIP/AES, WPS 2.0, Enterprise Security (EAP) STA only.
Modulation schemes	**2.4GHz** 11b - BPSK, QPSK, CCK 11g - BPSK, QPSK, 16QAM, 64 QAM 11n -PSK, QPSK, 16QAM, 64 QAM **5GHz** 11a/n/ac-BPSK, QPSK, 16QAM, 64 QAM
Antenna options	Antenna pin
USB host interface	Wi-Fi - USB 2.0
Max throughput	300Mbps
Maximum Transmit Power (dBm)	**Protocol** **Band** **FCC** **ETSI** Wi-Fi 2412MHz-2472MHz/2422MHz-2462MHz 19.14 16.95 Wi-Fi 5150MHz-5725MHz 15.72 19.2 Wi-Fi 5745MHz-5825MHz 16.06 13.66

Receive Sensitivity	-97.5dBm
WLAN bandwidths	20/40/80MHz

Table 1: EVIA Module Specifications

2 Features

2.1 WLAN Features

- Wi-Fi - Low power dual-band (2.4 and 5 GHz), 1-stream MU-MIMO 802.11ac
- WLAN TCP Throughput at 80 MHz 11ac: **300Mbps**
- WLAN Security
  - WPA/WPA2 Personal
  - Enterprise security (STA only)
  - WPS 2.0
- WLAN Encryption
  - WEP
  - TKIP
  - AES
- Operating modes
  - STA
  - SoftAP
  - P2P Group Owner and Client
  - STA + SoftAP
  - STA + P2P Group Owner
  - STA + P2P Client
- Power save
  - Module power saving features
    - Idle mode power save / Deep sleep
    - Legacy Protocol Power save / Beacon Mode Power Save
    - WMM-PS / UAPSD
    - Tx power-saving feature (GreenTx)
  - Host power saving features
    - WoW - Wake on Wireless (WLAN)
    - Offloading features: ARP, GTK , Neighbor solicitation (NS) offloading to the FW
- WMM and WMM-PS
- DFS Client
- Transmit beam forming
- 11r/FT roaming and Legacy fast roaming
- Supports Wi-Fi monitor mode

3 Module block Diagram

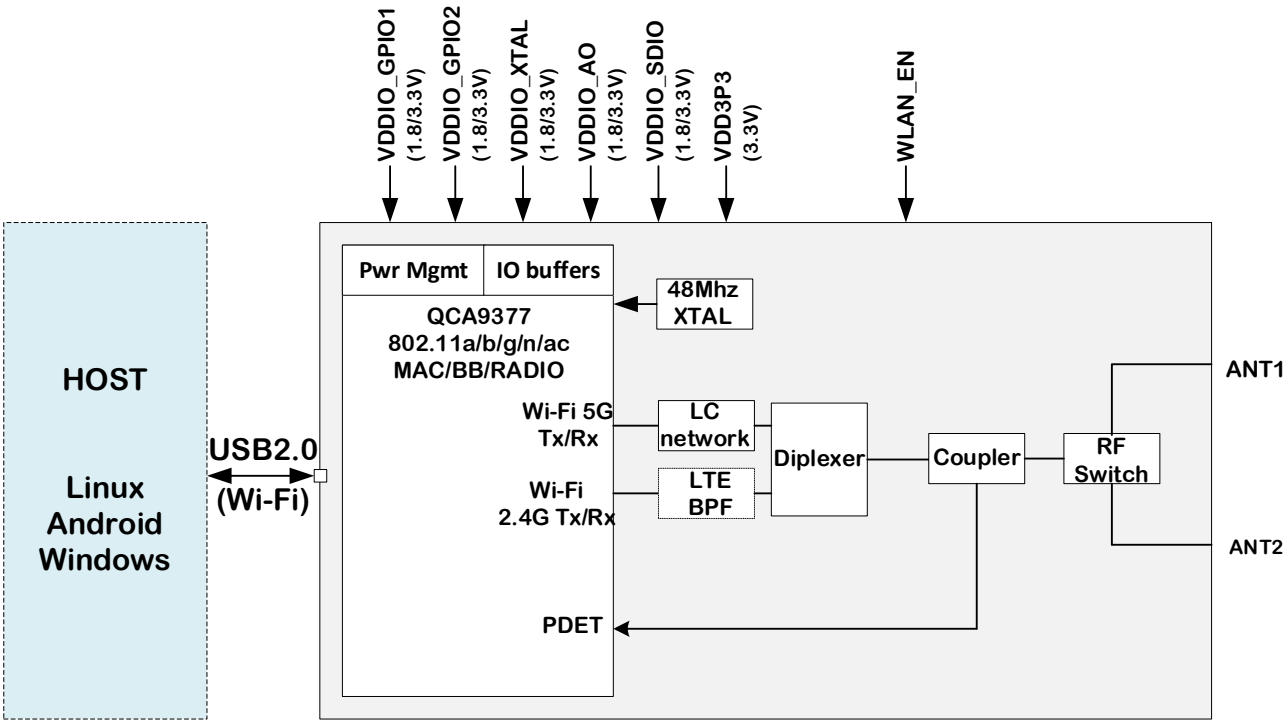

Figure 1: EVIA Block Diagram with Antenna Pin

4 Pin Definition

4.1 Pin-out with description

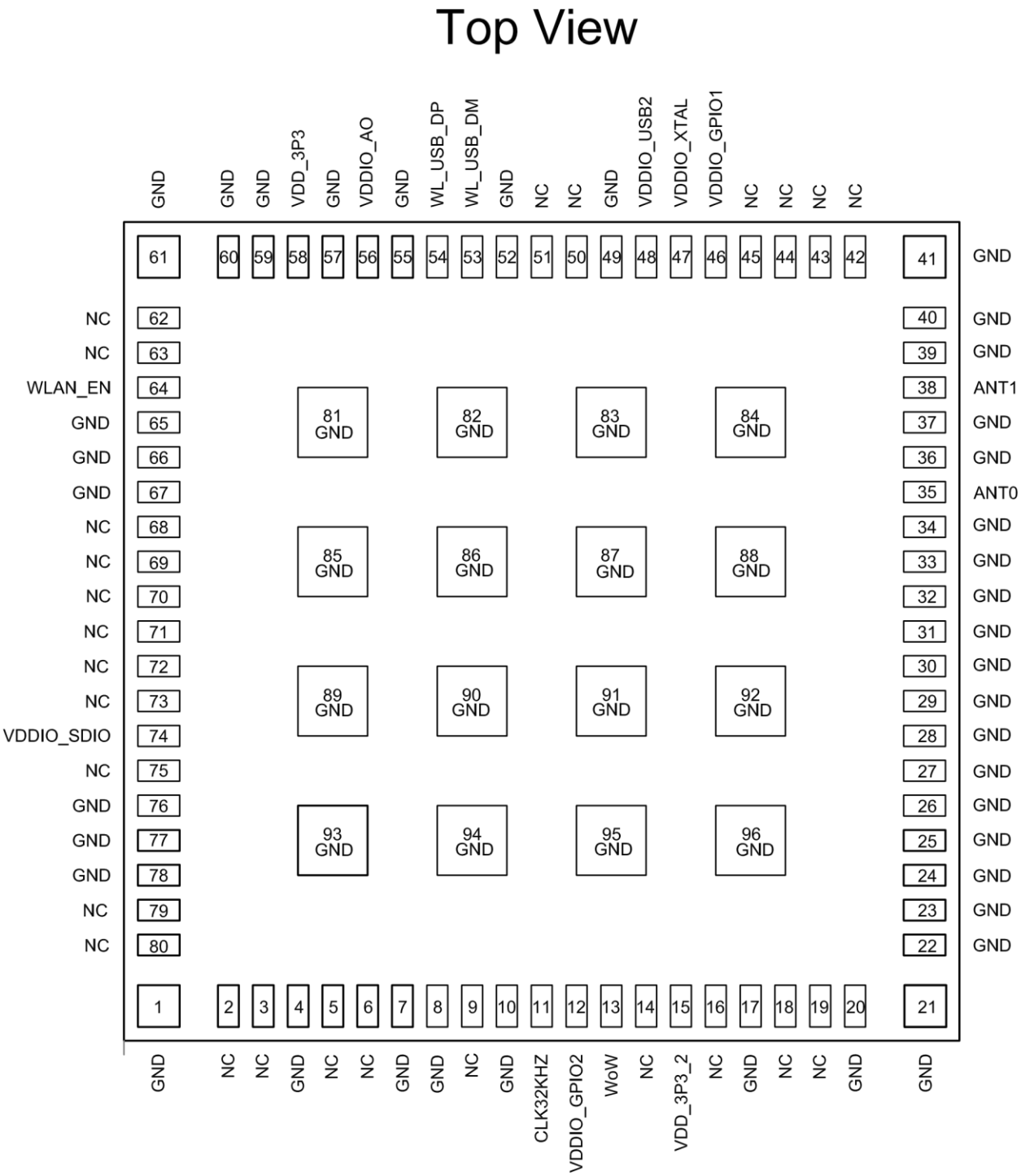

Figure 2: EVIA Module Pin Diagram

4.2 Pin Table

Pin Number	EVIA Pin Name USB	Pin Type	Voltage Ref	Description
1	GND	Ground	GND	Ground
2	NC	NC	NC	No connect
3	NC	NC	NC	No connect
4	GND	Ground	GND	Ground
5	NC	NC	NC	No connect
6	NC	NC	NC	No connect
7	GND	Ground	GND	Ground
8	GND	Ground	GND	Ground
9	NC	NC	NC	No connect
10	GND	Ground	GND	Ground
11	CLK32KHZ	I	VDDIO_GPIO2	Low frequency clock. 32KHz
12	VDDIO_GPIO2	Power	1.8V/3.3V	I/O power
13	WoW	O	VDDIO_GPIO2	Wake On Wireless (WoW). GPIO35
14	NC	NC	NC	No connect
15	VDD_3P3_2	Power	3.3V	Power
16	NC	NC	NC	NC
17	GND	Ground	GND	Ground
18	NC	NC	NC	NC
19	NC	NC	NC	NC
20	GND	Ground	GND	Ground
21	GND	Ground	GND	Ground
22	GND	Ground	GND	Ground
23	GND	Ground	GND	Ground
24	GND	Ground	GND	Ground
25	GND	Ground	GND	Ground
26	GND	Ground	GND	Ground
27	GND	Ground	GND	Ground
28	GND	Ground	GND	Ground
29	GND	Ground	GND	Ground
30	GND	Ground	GND	Ground
31	GND	Ground	GND	Ground

32	GND	Ground	GND	Ground
33	GND	Ground	GND	Ground
34	GND	Ground	GND	Ground
35	ANT0	AI/AO	RF	Antenna Pin 0
36	GND	Ground	GND	Ground
37	GND	Ground	GND	Ground
38	ANT1	AI/AO	RF	Antenna Pin 1
39	GND	Ground	GND	Ground
40	GND	Ground	GND	Ground
41	GND	Ground	GND	Ground
42	NC	NC	NC	No connect
43	NC	NC	NC	No connect
44	NC	NC	NC	No connect
45	NC	NC	NC	No connect
46	VDDIO_GPIO1	Power	1.8V/3.3V	I/O power for GPIO1 domain
47	VDDIO_XTAL	Power	1.8V/3.3V	I/O power for crystal
48	VDDIO_USB2	Power	3.3V	I/O power for USB2 domain
49	GND	Ground	GND	Ground
50	NC	NC	NC	No connect
51	NC	NC	NC	No connect
52	GND	Ground	GND	Ground
53	WL_USB_DM	AI/AO	VDDIO_USB2	WLAN+ for WLAN Interface
54	WL_USB_DP	AI/AO	VDDIO_USB2	WLAN- for WLAN Interface
55	GND	Ground	GND	Ground
56	VDDIO_AO	Power	1.8V/3.3V	I/O power for Always On logic
57	GND	Ground	GND	Ground
58	VDD_3P3	Power	3.3V	Power
59	GND	Ground	GND	Ground
60	GND	Ground	GND	Ground
61	GND	Ground	GND	Ground
62	NC	NC	NC	No connect
63	NC	NC	NC	No connect
64	WLAN_EN	I	VDDIO_AO	WLAN enable. Active high
65	GND	Ground	GND	Ground
66	GND	Ground	GND	Ground
67	GND	Ground	GND	Ground

68	NC	NC	NC	No connect
69	NC	NC	NC	No connect
70	NC	NC	NC	No connect
71	NC	NC	NC	No connect
72	NC	NC	NC	No connect
73	NC	NC	NC	No connect
74	VDDIO_SDIO	Power	1.8V/3.3V	I/O power for SDIO domain
75	NC	NC	NC	No connect
76	GND	Ground	GND	Ground
77	GND	Ground	GND	Ground
78	GND	Ground	GND	Ground
79	NC	NC	NC	No connect
80	NC	NC	NC	No connect
81	GND	Ground	GND	Ground
82	GND	Ground	GND	Ground
83	GND	Ground	GND	Ground
84	GND	Ground	GND	Ground
85	GND	Ground	GND	Ground
86	GND	Ground	GND	Ground
87	GND	Ground	GND	Ground
88	GND	Ground	GND	Ground
89	GND	Ground	GND	Ground
90	GND	Ground	GND	Ground
91	GND	Ground	GND	Ground
92	GND	Ground	GND	Ground
93	GND	Ground	GND	Ground
94	GND	Ground	GND	Ground
95	GND	Ground	GND	Ground
96	GND	Ground	GND	Ground

Table 2: EVIA Module Pin Table

5 Electrical Specifications

5.1 Absolute maximum ratings

Below table summarizes the absolute maximum ratings and Table 3 lists the recommended operating conditions for the EVIA. Beyond the range of Absolute maximum ratings/Recommended operating conditions may cause permanent damage.

Functional operation under these conditions only recommended.

NOTE: Operating condition ranges define those limits within which the functionality of the device is guaranteed. Where application information is given, it is advisory only and does not form part of the specification.

Symbol	Parameter	Min	Max	Unit
VDDIO_GPIO2	Voltage supply	-0.3	4.0	V
VDDIO_GPIO1	Voltage supply	-0.3	4.0	V
VDDIO_AO	Voltage supply	-0.3	4.0	V
VDDIO_XTAL	Voltage supply	-0.3	4.0	V
VDDIO_SDIO	Voltage supply	-0.3	4.0	V
VDD3P3	3.3 V supply	-0.3	4.0	V
RF_{IN}	Maximum RF input (reference to 50 Ω input)		+10	dBm
T_{STORE}	Storage temperature	-45	-45 to 135	°C
ESD	Electrostatic discharge tolerance	2000		V
3.3 V I/O VIH MAX	Maximum digital I/O input voltage for 3.3 V I/O supply		VDD + 0.3	V
1.8 V I/O VIH MAX	Maximum digital I/O input voltage for 1.8 V I/O supply		VDD + 0.2	V
VIH MIN	Minimum digital I/O input voltage for 1.8 V or 3.3 V I/O supply	-0.3		V

Table 3: Absolute maximum ratings

5.2 Recommended Operating Conditions

Symbol	Parameter	Min	Typ	Max	Unit
VDD3P3	3.3 V supply	3.135	3.3	3.465	V
VDDIO_GPIO2	Voltage supply	1.71	1.8 or 3.3	3.46	V
VDDIO_GPIO1	Voltage supply	1.71	1.8 or 3.3	3.46	V
VDDIO_AO	Voltage supply	1.71	1.8 or 3.3	3.46	V
VDDIO_XTAL	Voltage supply	1.71	1.8 or 3.3	3.46	V
VDDIO_SDIO	Voltage supply	1.71	1.8 or 3.3	3.46	V

T_{OP}	operating temperature (For I952HCx0device variant)	-40	–	85	°C
T_{CASE}	Case temperature	0	–	115	°C
PsiJT	Junction to the top center of the package thermal resistance	–	–	0.5	°C/W

Table 4: Recommended operating conditions

5.3 Digital logic characteristics

Symbol	Parameter	Comments	Min	Typ	Max	Unit
VIH	High-level input voltage		0.7 x VDDIO	-	VDDIO + 0.3	V
VIL	Low-level input voltage		-0.3	-	0.3 x VDDIO	V
VSHYS	Schmitt hysteresis		–	1.8 V IO: 375 3.3 V IO: 645	–	mV
RPULL	Input pull resistor	Up or down	–	1.8 V IO: 120 3.3 V IO: 70	–	kΩ
VOH	High-level output voltage		0.9 x VDDIO	–	VDDIO	V
VOL	Low-level output voltage		0	–	0.1 x VDDIO	V

Table 5: General DC electrical characteristics (for VDDIO = 3.3V I/O operation)

5.4 Performance specifications

5.4.1 WLAN RF characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Synthesizer composite characteristics for 2.4 GHz						
F_C	Center channel frequency	Center frequency at 5 MHz spacing	2.412	–	2.472	GHz
F_{REF}	Reference oscillator frequency	±20 ppm	–	48	–	MHz
$TS_{POWERUP}$	Time for power up (from sleep)		–	0.2	–	ms
Synthesizer composite characteristics for 5 GHz						

F_C	Center channel frequency	Center frequency at 5 MHz spacing	5.150		5.825	GHz
F_{REF}	Reference oscillator frequency	±20 ppm	–	48	–	MHz
$TS_{POWERUP}$	Time for power up (from sleep)		–	0.2	–	ms
Transmit output power accuracy						
A_{PC}	Accuracy of transmit power control at 2.4 GHz at room temperature		–	±1.9	–	dB
A_{PC}	Accuracy of transmit power control at 5 GHz at room temperature		–	±2.4	–	dB

Table 6: WLAN RF characteristics per chain operation

Note: All A_{PC} numbers assume a test conducted with a 50 Ω load.

5.4.1.1 Transmit Power at 2.4 GHz

Note: All typical values may vary ±1.5 dB

Standard	Modulation	Data rates	2.4 GHz: Transmit power with IEEE 802.11 EVM and spectral mask compliance at chip output at 25°C			
		Index	802.11b/g	802.11n/ac 20 MHz	802.11n/ac 40 MHz	Unit
			Typ	Typ	Typ	
802.11b	BPSK	1 Mbps	16.0	–	–	dBm
	QPSK	2 Mbps	16.0	–	–	dBm
	CCK	5.5 Mbps	16.0	–	–	dBm
	CCK	11 Mbps	16.0	–	–	dBm
802.11g	BPSK	6 Mbps	18.0	–	–	dBm
	BPSK	9 Mbps	18.0	–	–	dBm
	QPSK	12 Mbps	18.0	–	–	dBm
	QPSK	18 Mbps	18.0	–	–	dBm
	16 QAM	24 Mbps	18.0	–	–	dBm
	16 QAM	36 Mbps	18.0	–	–	dBm
	64 QAM	48 Mbps	18.0	–	–	dBm

	64 QAM	54 Mbps	18.0	–	–	dBm
802.11n/ac	BPSK	MCS0	–	18.0	16.0	dBm
	QPSK	MCS1	–	18.0	16.0	dBm
	QPSK	MCS2	–	18.0	16.0	dBm
	16 QAM	MCS3	–	18.0	16.0	dBm
	16 QAM	MCS4	–	18.0	16.0	dBm
	64 QAM	MCS5	–	18.0	16.0	dBm
	64 QAM	MCS6	–	18.0	16.0	dBm
	64 QAM	MCS7	–	18.0	16.0	dBm
802.11ac	256 QAM	MCS8	–	15.0	16.0	dBm
	256 QAM	MCS9	–	15.0	16.0	dBm

Table 7: Transmit power at 2.4 GHz

5.4.1.2 Transmit Power at 5 GHz

Note: All typical values may vary ±1.5 dB

Standard	**Modulation**	**Data rates**	**5 GHz: Transmit power with IEEE 802.11 EVM and spectral mask compliance at chip output at 25°C**				
		Index	**802.11a**	**802.11n/ac 20 MHz**	**802.11n/ac 40 MHz**	**802.11ac 80 MHz**	**Unit**
			Typ	**Typ**	**Typ**	**Typ**	
802.11a	BPSK	6 Mbps	14.0	–	–	–	dBm
	BPSK	9 Mbps	14.0	–	–	–	dBm
	QPSK	12 Mbps	14.0	–	–	–	dBm
	QPSK	18 Mbps	14.0	–	–	–	dBm
	16 QAM	24 Mbps	14.0	–	–	–	dBm
	16 QAM	36 Mbps	14.0	–	–	–	dBm
	64 QAM	48 Mbps	14.0	–	–	–	dBm
	64 QAM	54 Mbps	14.0	–	–	–	dBm
802.11n/ac	BPSK	MCS0	–	14.0	12.0	_	dBm

	QPSK	MCS1	–	14.0	12.0	_	dBm
	QPSK	MCS2	–	14.0	12.0	_	dBm
	16 QAM	MCS3	–	14.0	12.0	_	dBm
	16 QAM	MCS4	–	14.0	12.0	_	dBm
	64 QAM	MCS5	–	14.0	12.0	_	dBm
	64 QAM	MCS6	–	14.0	12.0	_	dBm
	64 QAM	MCS7	–	14.0	12.0	_	dBm
802.11ac	256 QAM	MCS8	–	14.0	14.0	14.0	dBm
	256 QAM	MCS9	–	14.0	14.0	14.0	dBm

Table 8: Transmit power at 5 GHz

5.4.1.3 Receive minimum input level sensitivity at chip input at 2.4 GHz for configuration at 25°C

Note: All typical values may vary ±1.0 dB

Standard	**Modulation**	**Data rates**	**2.4 GHz: IEEE receive minimum input level sensitivity at chip input with 10% packet error rate (100 bytes at 11b and 1000 bytes at OFDM) at 25°C, LDPC enabled**			
		Index	**802.11b/g**	**802.11n/ac 20 MHz**	**802.11n/ac 40 MHz**	**Unit**
			Typ	**Typ**	**Typ**	
802.11b	BPSK	1 Mbps	-99.5	–	–	dBm
	CCK	11 Mbps	-92.0	–	–	dBm
802.11g	BPSK	6 Mbps	-94.0	–	–	dBm
	64 QAM	54 Mbps	-78.0	–	–	dBm
802.11n/ac	BPSK	1SS MCS0	–	-94.0	-91.0	dBm
	64 QAM	1SS MCS7	–	-77.0	-72.0	dBm
802.11ac	256 QAM	1SS MCS8	–	-73.0	-70.0	dBm
	256 QAM	1SS MCS9	–	–	-69.0	dBm

Table 9: Receive minimum input level sensitivity at chip input at 2.4 GHz for configuration at 25°C

Receive minimum input level sensitivity at chip input at 5 GHz at 25°C

Note: All typical values may vary ±1.0 dB

Standard	Mod	Data rates	5 GHz: IEEE receive minimum input level sensitivity at chip input with 10% packet error rate (1000 bytes) at 25°C, LDPC enabled				
		Index	802.11a	802.11n/ac 20 MHz	802.11n/ac 40 MHz	802.11n/ac 80 MHz	Unit
			Typ	Typ	Typ	Typ	
802.11a	BPSK	6 Mbps	-94.0	–	–	–	dBm
	64 QAM	54 Mbps	-77.0	–	–	–	dBm
802.11n/ac	BPSK	1SS MCS0	–	-94.0	-91.0	-88.0	dBm
	64 QAM	1SS MCS7	–	-76.5	-74.0	-70.0	dBm
802.11ac	256 QAM	1SS MCS8	–	–	-72.5	-68.0	dBm
	256 QAM	1SS MCS9	–	–	–	-64.0	dBm

Table 10: Receive minimum input level sensitivity at chip input at 5 GHz at 25°C

5.4.1.4 Maximum input level sensitivity at 25°Cs

Maximum input level sensitivity at chip input					
Standard	**Band**	**Modulation**	**IEEE max input level**	**Max input level at chip input**	**Unit**
802.11b	2.4 GHz	DBPSK	-4	-5.5	dBm
802.11b	2.4 GHz	CCK	-10	-5	dBm
802.11g	2.4 GHz	OFDM	-20	-10	dBm
802.11a	5 GHz	OFDM	-30	-10	dBm
802.11n	2.4 GHz	OFDM	-20	-10	dBm
	5 GHz	OFDM	-30	-10	dBm
802.11ac	2.4 GHz	OFDM	-30	-10	dBm
	5 GHz	OFDM	-30	-10	dBm

Table 11: Maximum input level sensitivity at 25°C

6 Software

6.1 Software Architecture

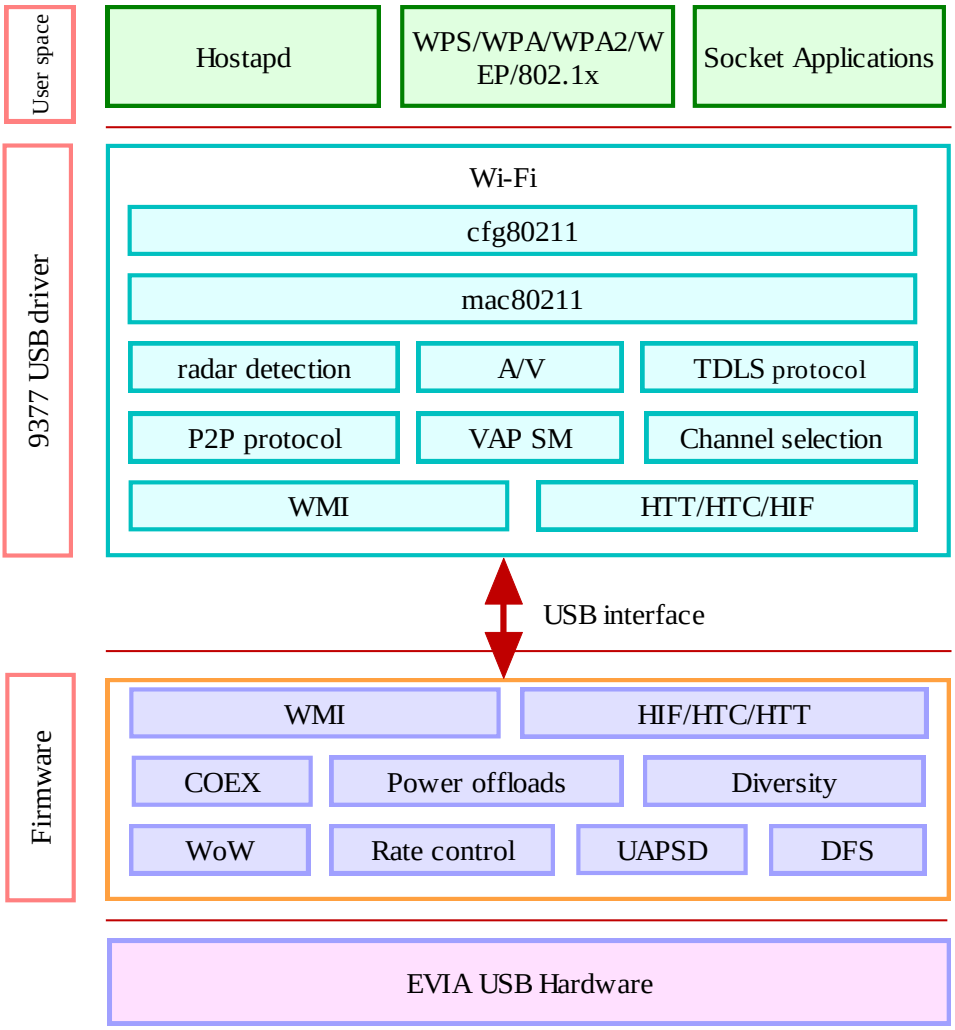

Figure 3: EVIA Software Architecture

6.2 WLAN

Drivers are available for Linux (Kernel Version 4.4.15, 4.9.11 and 4.11), Android Nougat and Windows 10.

- Refer to USB DVK User Guide for more details about driver and testing procedures

7 Package Description

7.1 Mechanical characteristics

Parameter	Value (L X W X H)	Units
Module Dimensions	11.75 X 12 X 1.6	mm
Tolerance	+/- 0.15	mm

Table 12: Mechanical characteristics

7.2 Physical Dimensions, Pad Location and Landing Pattern

Please see 'BALI series Module Integration Guide (MIG)'

8 Regulatory Qualifications and Approvals

BALI series modules hold full modular approvals and are certified for FCC, IC, CE/ETSI and TELEC for use in USA, Canada, Europe and Japan respectively. End product manufacturers can inherit the module approvals for compliance testing of their device by strictly following grantee's compliance guidelines for module integration and operation and can avoid further testing of module transmitter function.

For detailed information on how to integrate BALI series modules for leveraging the module certification, please see 'BALI series Regulatory Compliance App Note'.

8.1 FCC Compliance

BALI series modules are intended for OEM integrators only. These integrators should make sure that the end product using BALI series module uses only authorized antennas and is compliant to all rules.
End user manual shall include all the required regulatory information given in this manual.

8.1.1 FCC Compliance Statement

This equipment has been tested and found to compliant with part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

§15.19 Statement

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

§15.21 Information to user:

Warning: changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

8.1.2 RF Exposure compliance statement

This Module complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20cm between the radiator

and your body. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter except in accordance with FCC multi-transmitter guidelines.

8.1.3 Labelling Instruction for Host Product Integrator

Please notice that if the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

"Contains FCC ID: 2AYLDI95" or

"Contains Transmitter Module FCC ID: 2AYLDI95"

§ 15.19 Labelling requirements shall be complied on end user device.

Labelling rules for special device, please refer to *§2.925, § 15.19 (a)(5)* and relevant KDB publications. For E-label, please refer to *§2.935*.

8.1.4 Installation Notice to Host Product Manufacturer

The OEM integrator is responsible for ensuring that the end-user has no manual instruction to remove or install module.

RF exposure compliance instruction

The module is limited to installation in mobile application, a separate approval is required for all other operating configurations, including portable configurations with respect to §*2.1093*, co-location with another transmitter and difference in antenna configurations.

Host product manufacturer shall at least provide information of minimum separation distance to end users in RF exposure compliance statement to end users in their end-product manuals.

8.1.5 Antenna Change Notice to Host manufacturer

Module integrators are recommend using antenna which is certified with this module mentioned in this manual. Module integrators can use their own antenna but must ensure it is of same type and of equal or less gain as of certified antenna. No retesting of this system configuration is required. Refer to FCC Part 15.20 (c)(4).

If you desire to increase antenna gain and either change antenna type or use same antenna type certified, a Class II permissive change application is required to be filed by us, or you (host manufacturer) can take responsibility through the change in FCC ID (new application) procedure followed by a Class II permissive change application based on new emissions testing. Please perform testing on frequency bands where the antenna gain is highest, worst-case band-edges based on original filing, and only on frequency bands where the antenna gain is highest. See §2.1043. Contact Ivativ representative before adding different antennas(The antenna is not a trace antenna).

8.1.6 FCC other Parts, Part 15B Compliance Requirements for Host product manufacturer

This modular transmitter is only FCC authorized for the specific rule parts listed on our grant, host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification.

Host manufacturer in any case shall ensure host product which is installed and operating with the module is in compliant with Part 15B requirements.

Please note that For a Class B or Class A digital device or peripheral, the instructions furnished in the user manual of the end-user product shall include statement set out in *§15.105 Information to the user* or such similar statement and place it in a prominent location of host product manual. Original texts from FCC Rules are as following you may refer to:

For Class B

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:
—Reorient or relocate the receiving antenna.
—Increase the separation between the equipment and receiver.
—Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
—Consult the dealer or an experienced radio/TV technician for help.

For Class A

Note: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Additionally, investigative spot check measurements are strongly recommended to verify the full system compliance after module integration and operating in intended use case. For more information on end product test guidance please check KDB 996369 D04 Module Integration Guide V02.

8.2 IC

BALI series radio transmitter IC:26840-I95 has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

A list of all antenna types

Item #	Part Number	Manufacturer	Description	Gain dBi
1	GW.59.3153	Taoglas	2.4GHz/5.1~5.85GHz RP_SMA male dipole antenna. 50 Ohm impedance	2.4 - 2.5GHz: 2.37dBi 5.15 - 5.85GHz: 2.93dBi

Cet émetteur radio IC:26840-I95 a été approuvé par innovation, sciences et développement économique Canada pour fonctionner avec les types d'antennes énumérés ci - dessous et afficher le gain maximal autorisé. Les types d'antennes qui ne sont pas inclus dans cette liste sont strictement interdits avec cet appareil si leur gain est supérieur au gain maximal de l'un des types énumérés.

Liste de tous les types d'antennes

Item #	Part Number	Manufacturer	Description	Gain dBi
1	GW.59.3153	Taoglas	2.4GHz/5.1~5.85GHz RP_SMA male dipole antenna. 50 Ohm impedance	2.4 - 2.5GHz: 2.37dBi 5.15 - 5.85GHz: 2.93dBi

8.2.1 ISED compliance statement

This device contains license-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's license-exempt RSS(s). Operation is subject to the following two conditions:
(1) This device may not cause interference.
(2) This device must accept any interference, including interference that may cause undesired operation of the device.

L'émetteur/récepteur exempt de license contenu dans le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :
(1) L'appareil ne doit pas produire de brouillage;
(2) L'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

The user manual for LE-LAN devices shall contain instructions related to the restrictions mentioned in the above sections, namely that:

i. the device for operation in the band 5150–5250 MHz is only for indoor use to reduce the potential for harmful interference to co-channel mobile satellite systems;

i. le dispositif utilisé dans la bande 5150-5250 MHz est réservé à une utilisation en intérieur afin de réduire le risque de brouillage préjudiciable aux systèmes mobiles par satellite dans le même canal;

8.2.2 ISED Radiation Exposure statement

This equipment complies with IC RSS-102 radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20 cm between the radiator and your body.
Cet équipement est conforme aux limites d'exposition aux radiations IC CNR-102 établies pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec une distance minimale de 20 cm entre le radiateur et votre corps.

8.2.3 End Product Labeling instruction

Please notice that if the IC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

“Contains IC:26840-I95” or any similar wording that expresses the same meaning may be used.

L’étiquette d’homologation d’un module d’Innovation, Sciences et Développement économique Canada devra être posée sur le produit hôte à un endroit bien en vue, en tout temps. En l’absence d’étiquette, le produit hôte doit porter une étiquette sur laquelle figure le numéro d’homologation du module d’Innovation, Sciences et Développement économique Canada, précédé du mot « contient », ou d’une formulation similaire allant dans le même sens et qui va comme suit :

“Contient IC:26840-I95” est le numéro d’homologation du module

8.3 CE

BALI series modules comply with the essential requirements and other relevant provisions of the Radio Equipment Directive (RED) 2014/53/EU. BALI series modules are compliant with directive 2011/65/EU (EU RoHS 2) and its amendment directive 2015/863 (EU RoHS 3). In European market, it is the end product manufacturer who is ultimately responsible for the compliance of their device.

For more information on EU regulatory compliance of BALI series modules, please see BALI series Declaration of Conformity and RoHS Declaration. Test reports are available on request.

8.4 TELEC

BALI Series modules comply with Japanese regulatory requirements of MIC certification Item 19, Article 2, Paragraph 1. Test reports are available on request.

8.5 Pre-Approved antennas

BALI series modules are certified with the following antennas.

Item #	Part Number	Manufacturer	Description	Gain dBi
1	GW.59.3153	Taoglas	2.4GHz/5.1~5.85GHz RP_SMA male dipole antenna. 50 Ohm impedance	2.4 - 2.5GHz: 2.37dBi 5.15 - 5.85GHz: 2.93dBi

Table 13: Certified Antennas

9 Product Shipping, Storage and Handling

9.1 Packaging Information

EVIA modules are delivered as hermetically sealed trays and reels. For more information, please refer to 'Ivativ Package Shipping, Storage and Handling Guide'.

9.2 Storage and Baking Instructions

EVIA modules are moisture sensitive devices and are rated at MSL 3. The new packages contain desiccate to absorb moisture and humidity indicator card to display the moisture level maintained during storage and shipment. If the card recommends baking, bake the parts in accordance with JEDEC standard J-STD-033. Floor life for these modules is 168 hours of factory conditions (≤ 30°C, 60% RH). For more information, please refer to 'Ivativ Package Shipping, Storage and Handling Guide'.

9.3 Mounting process and soldering recommendations

Please see 'BALI Series Module Integration Guide'.

10 Product label and ordering information

The labels of 195xHC00 series include important product information.

Below figure illustrates EVIA USB Product labeling, it includes: the Product name, Data code, Lot number and Certifications. Table 18 illustrates the complete description about EVIA Product labeling.

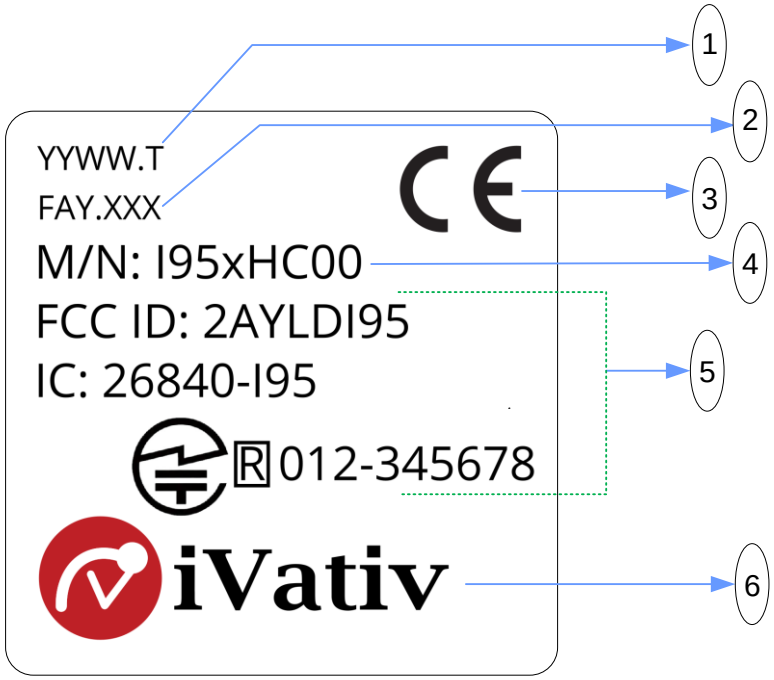

Figure 4: Product Labeling

The table below describes the markings on the label.

Reference	Description
1	Date Code. YYWW.T: Year/Week/Temp Grade
2	Lot Number. FAY.XXX FAY: Fab, assembly and single digit year of make XXX: Lot number
3	CE Mark
4	Model number. Where 'x' indicates host interface 0- SDIO interface 1- PCIe interface 2- USB interface
5	Certification IDs and GITEKI mark
6	Ivativ Logo. Round logo symbol indicates the pin 1, unless marked specifically

Table 14: Module Label Description

10.1 Part ordering

EVIA

I952HC00-I0LT	EVIA USB module with Antenna Pin, Tray packing
I952HC00-I0LR	EVIA USB module with Antenna Pin, Tape and Reel packing

Table 15: Part Ordering for EVIA

EVIA - EVK/DVK

I952HC00-I0L-EVK	EVIA USB Industrial Temp, Antenna Pin EVK
I952HC00-I0L-DVK	EVIA USB Industrial Temp, Antenna Pin DVK Kit

Table 16: Part ordering for EVIA EVK/DVK

Contact Information

Please contact info@ivativ.com